

2022 ICICSP

September 16th (Fri.) - September 18th (Sun.), 2022
Shenzhen, China

2022 5th
International Conference on
Information Communication
and Signal Processing

About Us

The 2022 5th International Conference on Information Communication and Signal Processing (ICICSP 2022) will be held in Shenzhen, China on September 16–18, 2022, co-sponsored by IEEE and Shenzhen University (China), hosted by the College of Electronics and Information Engineering (Shenzhen University), co-organized by the 54th Research Institute of China Electronics Technology Group Corporation (China), Peng Cheng Laboratory, Qian Xuesen Laboratory of Space Technology, and Radar Society of CIE, and technical co-sponsored by Shanghai Jiao Tong University (China).

ICICSP is initiated in 2018. It was held successfully in Singapore (2018, Nanyang Technological University) and China (2019, Shandong University (Weihai); 2021, Shanghai Jiao Tong University (Shanghai), and a fully virtual conference was held in 2020 due to the COVID-19.

Publication

The ICICSP 2018–2021 conference proceedings have been published by IEEE and indexed by Ei Compendex and Scopus, while all the accepted papers in the 5th ICICSP will be published in the 2022 conference proceedings by IEEE and submitted to Ei Compendex and Scopus indexing as well.

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Call for papers

- Biomedical Engineering
- Multidimensional Signal Processing
- Image and video Processing
- Error concealment
- Network Security
- Protocols
- MIMO – theory and trials
- Diversity techniques
- Spread Spect rum and CDMA systems
- Ultra Wide-Band
- Mobile Computing ect.

More topics: <http://icsp.org/cfp.html>

Special Sessions

1-UNDERWATER ACOUSTICS, OCEAN EXPLORATION AND SIGNAL PROCESSING

- Underwater acoustics and array signal processing
- Underwater noise modelling and measurements
- Sound propagation in shallow and deep water...etc

<http://www.icsp.org/session1.html>

2-ACOUSTIC MEASUREMENT AND SIGNAL PROCESSING OF AIRCRAFT AND THEIR EQUIPMENT

- Aeroacoustic signal processing
- Acoustic/vibration
- Aero-engine acoustic testing and signal processing
- Aeroacoustic detection and security...etc

<http://www.icsp.org/session2.html>

3-SPACE SENSING, INFORMATION INTERPRETATION AND INTELLIGENT APPLICATION

- One-bit Radar Sensing Technology
- Artificial Intelligence and Radar Information Interpretation
- Light-weight Neural Network
- Intelligent Control and Application...etc

<http://www.icsp.org/session3.html>

Submission and Date

Full Paper(publication and oral presentation)

Abstract(oral presentation only)

Electronic Submission System (.pdf)

<http://www.easychair.org/conferences/?conf=icicsp2022>

or via conference email: icicsp@vip.163.com

Paper Template: <http://www.icsp.org/template.docx>

Submission Deadline	April 30, 2022
Notification Date	May 30, 2022
Registration Deadline (Early Bird)	June 15, 2022

Contact

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